

L Number	Hits	Search Text	DB	Time stamp
-	3112	electrode near10 thick near10 thin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:29
-	206	(electrode near10 thick near10 thin).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:31
-	87	(electrode near5 thick near5 thin).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:30
-	1	((electrode near5 thick near5 thin).clm.) and (package or packaging).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:30
-	1	((electrode near10 thick near10 thin).clm.) and (package or packaging).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:31
-	3112	electrode near10 thick near10 thin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:31
-	27	(electrode near10 thick near10 thin) and (package or packaging).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:32
-	274	(electrode near10 thick near10 thin) and (package or packaging)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:32
-	179	((electrode near10 thick near10 thin) and (package or packaging)) and (mount or mounting or mounted)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:32
-	179	((electrode near10 thick near10 thin) and (package or packaging)) and (mount or mounting or mounted)) and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:32

114	((electrode near10 thick near10 thin) and (package or packaging)) and (mount or mounting or mounted)) and electrode.clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:32
31	((electrode near10 thick near10 thin) and (package or packaging)) and (mount or mounting or mounted)) and electrode.clm.) and (mount or mounting or mounted).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/21 15:33
22	(US-5648682-\$ or US-6329711-\$ or US-4899209-\$ or US-5493151-\$ or US-5834831-\$ or US-5929513-\$ or US-5894107-\$ or US-5986337-\$ or US-5777380-\$ or US-5844779-\$ or US-5619065-\$ or US-5859471-\$ or US-5291375-\$ or US-5977613-\$ or US-5521429-\$ or US-5378657-\$ or US-5329159-\$ or US-6255740-\$ or US-6091134-\$).did. or (US-20010001504-\$ or US-20020005573-\$ or US-20010033008-\$).did.	USPAT; US-PGPUB	2003/03/17 11:50
202	electrode same (thick adj portion) same (thin adj portion)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 11:51
31	(electrode same (thick adj portion) same (thin adj portion)) and (electrode same (thick adj portion) same (thin adj portion)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 11:55
20	(electrode same (thick adj portion) same (thin adj portion)) and (electrode near10 (thick adj portion) near10 (thin adj portion)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 11:58
2	((electrode same (thick adj portion) same (thin adj portion)) and (electrode near10 (thick adj portion) near10 (thin adj portion)).clm.) and (mount or mounting or mounted).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 11:57
3	(electrode same (thick adj portion) same (thin adj portion)) and (electrode near10 (thick or thicker) near10 (thin or thinner)).clm. and (package or packaging or packaged).ti,ab,clm. and (mount or mounting or mounted).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:00
1270	external near connection near electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:01

-	374	(external adj connection adj electrode).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:03
-	34	((external adj connection adj electrode).ti,ab,clm.) and (epoxy or resin).ti,ab,clm. and (package or packaging or packaged).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:03
-	0	(external near2 electrode).clm. and ((thick or thin or thinner or thicker) near electrode).clm. and (package or packaging or packaged).ti,ab,clm. and (resin or epoxy).ti,ab,clm. and (mount or mounting or mounted).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:05
-	0	(external near10 electrode).clm. and ((thick or thin or thinner or thicker) near electrode).clm. and (package or packaging or packaged).ti,ab,clm. and (resin or epoxy).ti,ab,clm. and (mount or mounting or mounted).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:06
-	61	(external near10 electrode).clm. and ((thick or thin or thinner or thicker) near electrode).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:09
-	477	(package or packaging or packaged).ti,ab,clm. and (epoxy or resin).ti,ab,clm. and (mount or mounting or mounted).ti,ab,clm. and electrode.clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:10
-	12	((package or packaging or packaged).ti,ab,clm. and (epoxy or resin).ti,ab,clm. and (mount or mounting or mounted).ti,ab,clm. and electrode.clm.) and (electrode near5 (thick or thicker or thin or thinner)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:12
-	3070	(electrode near2 (thin or thinner or thick or thicker)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:13
-	14	((electrode near2 (thin or thinner or thick or thicker)).clm.) and (package or packaging or packaged).ti,ab,clm. and (epoxy or resin).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:14

169	(((mount or mounting or mounted) near5 surface near5 (package or packaging or packaged).clm.) and (resin or epoxy).clm.) and (package or packaging).ab.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:45
41512	(package or packaging or packaged).ab. and (package or packaging or packaged).clm. (thick or thin or thinner or thicker).clm. and (resin or epoxy).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:47
31125	(package or packaging or packaged).ab. and (package or packaging or packaged).clm. ((thick or thin or thinner or thicker) adj (portion or section or part)).clm. and (resin or epoxy).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:51
10060	((package or packaging or packaged).ab. and (package or packaging or packaged).clm. ((thick or thin or thinner or thicker) adj (portion or section or part)).clm. and (resin or epoxy).clm.) and (mount or mounting or mounted).ti,ab,clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:51
7	(((package or packaging or packaged).ab. and (package or packaging or packaged).clm. ((thick or thin or thinner or thicker) adj (portion or section or part)).clm. and (resin or epoxy).clm.) and (mount or mounting or mounted).ti,ab,clm.) and ((electrode or lead) near (thick or thin or thicker or thinner) near (portion or section or part)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 12:56
58	((electrode or lead) near (thick or thin or thicker or thinner) near (portion or section or part)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 13:05
4	((electrode or lead) near2 (thick or thin or thicker or thinner) near2 (portion or section or part)).clm. and (epoxy or resin).clm. and (package or packaging or packaged).ab. and (package or packaging or packaged).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 13:08
9	((electrode or lead) near3 (thick or thin or thicker or thinner) near3 (portion or section or part)).clm. and (epoxy or resin).clm. and (package or packaging or packaged).ab. and (package or packaging or packaged).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 13:12
13	((electrode or lead) near5 (thick or thin or thicker or thinner) near5 (portion or section or part)).clm. and (epoxy or resin).clm. and (package or packaging or packaged).ab. and (package or packaging or packaged).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/17 13:29



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